Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: CHEN-HUA YU, HORNG-HUEI TSENG

For: METHOD OF SELECTIVELY MAKING COPPER USING PLATING TECHNOLOGY

Enclosed are:					
X 4 sheets of	f drawing(s) - formal.				
X An assignment of the invention to Taiwan Semicondutor Manufacturing Co.					
An associat	te power of attorney	Applicant claims	small entity status		
Request &	Certification under 35 U	SC 122(b)(2)(b)(i)			
The filing fee has bee	n calculated as shown be	:low:			
	(Col. 1)	(Col. 2)	OTHER THAN	A SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE	
BASIC FEE				\$ 750.	
TOTAL CLAIMS	33 -20=	13	x 18 =	\$ 234.	
INDEP CLAIMS	2 -3=	0	x 84 =	\$ 0.	
		SI	JB TOTAL	\$ 984.	
		A	SSIGNMENT	\$40.	
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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

Date of deposit

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